



# Display & Mobile Product Data Sheet

## LTW-K140SXR85

Spec No.: DS23-2015-0011

Effective Date: 05/13/2015

Revision: -

**LITE-ON DCC**

**RELEASE**

BNS-OD-FC001/A4

## 1. Description

The LiteON K140 Product is a wide beam angle standard-dimension package, combining the lifetime and reliability advantages of Light Emitting Diodes with the brightness of conventional lighting. It gives you total design freedom and unmatched brightness, creating a new opportunities for solid state lighting to displace conventional lighting technologies.

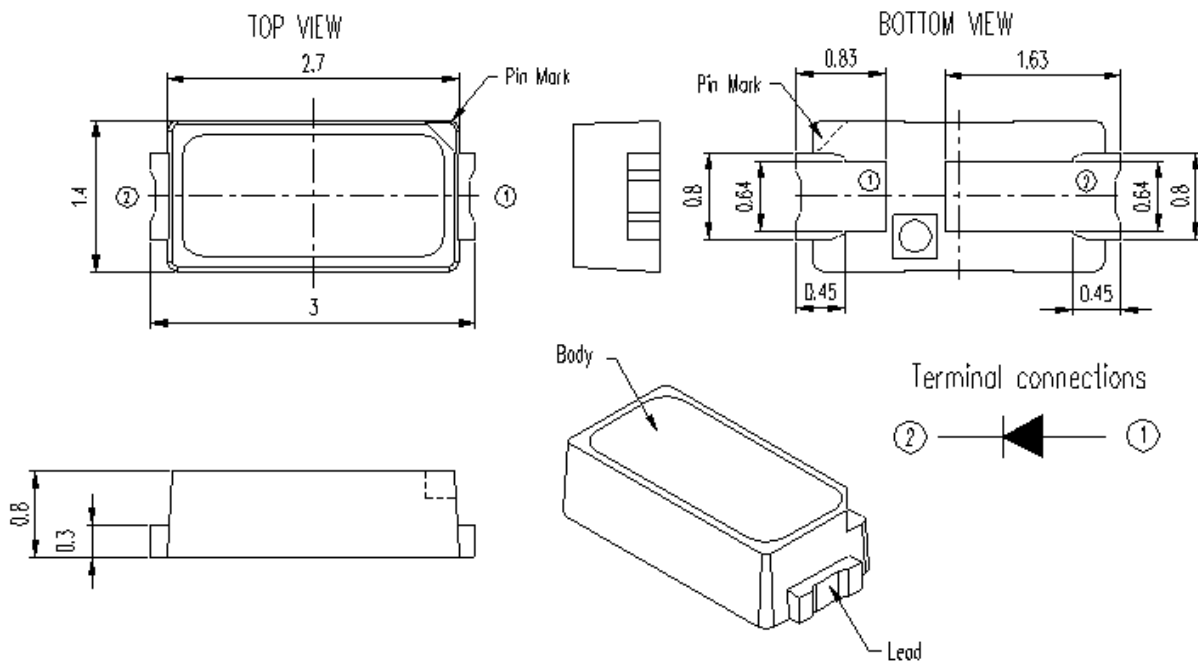
### 1.1 Features

- Package in 8mm tape on 7" diameter reels.
- Compatible with automatic placement equipment.
- Compatible with infrared and vapor phase reflow solder process.
- EIA STD package.
- I.C. compatible.
- Meet green product and Pb-free(According to RoHS)

### 1.2 Available Part Numbers

CCT	Part Number
8500K	LTW-K140SXR85

## 2. Outline Dimensions



Part No.	Lens Color	Source Color
LTW-K140SXR85	Yellow	InGaN Blue

### Notes:

1. All dimensions are in millimeters.
2. Tolerance is  $\pm 0.1$  mm (.008") unless otherwise noted.

### 3. Absolute Maximum Ratings at $T_a=25^{\circ}\text{C}$

Parameter	Symbol	Rating	Unit
Power Dissipation	$P_o$	280	mW
Continuous Forward Current	$I_F$	80	mA
Pulse Forward Current	$I_{FP}$	105	mA
Operating Temperature Range	$T_{opr}$	-40 ~ +80	$^{\circ}\text{C}$
Storage Temperature Range	$T_{stg}$	-40 ~ +100	$^{\circ}\text{C}$
Junction Temperature	$T_j$	$\leq 100$	$^{\circ}\text{C}$

#### Notes :

1. Forbid to operating at reverse voltage condition for long.
2. 1/10 duty cycle, Pulse width  $\leq 100 \mu\text{s}$ .

## 4. Electro-Optical Characteristics

### 4.1 Typical Performance

Parameter	Symbol	Values		Unit	Test Condition
Chromaticity Coordinates	x	Typ.	0.292	-	$I_F = 60\text{mA}$
	y	Typ.	0.306		
Luminous Flux <sup>1</sup>	$\Phi_v$	Min	19.4	lm	
		Typ.	23.0		
		Max.	29.0		
Viewing Angle	$2\theta_{1/2}$	Typ.	120	deg	
Forward Voltage	$V_F$	Min	2.9	V	
		Typ.	3.2		
		Max.	3.5		

### Notes

- Luminous flux is the total luminous flux output as measured with an integrating sphere.
- Iv (flux  $\Phi_v$ ) classification code is marked on each packing bag.
- The chromaticity coordinates (x, y) is derived from the 1931 CIE chromaticity diagram.
- Caution in ESD:

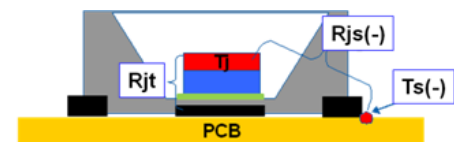
Static Electricity and surge damages the LED. It is recommended using a wrist band or anti-electrostatic glove when handling the LED. All devices, equipment and machinery must be properly grounded.

- CAS140B is the test standard for the chromaticity coordinates (x, y) &  $\Phi_v$  &  $V_F$
- The chromaticity coordinates (x, y) guarantee should be added +/- 0.01 tolerances
- Luminous Flux measurement allowance is  $\pm 10\%$
- Voltage measurement allowance is  $\pm 0.1\text{ V}$
- The Thermal Resistance is defined

as the figure,  $R_{jt}$  is the  $R_{th}$  from  $T_j$  to Thermal Pad Solder:

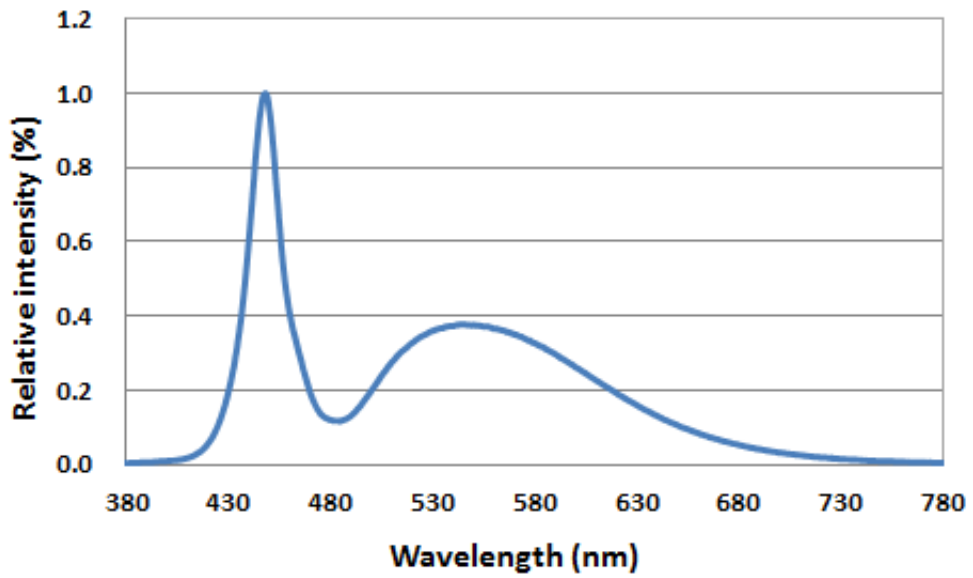
Reference for thermal resistance:

Using 2.5x 2.5x 0.17 cm Aluminum MCPCB,  $R_{jt}=30^\circ\text{C/W}$ ,  $R_{js}=35^\circ\text{C/W}$

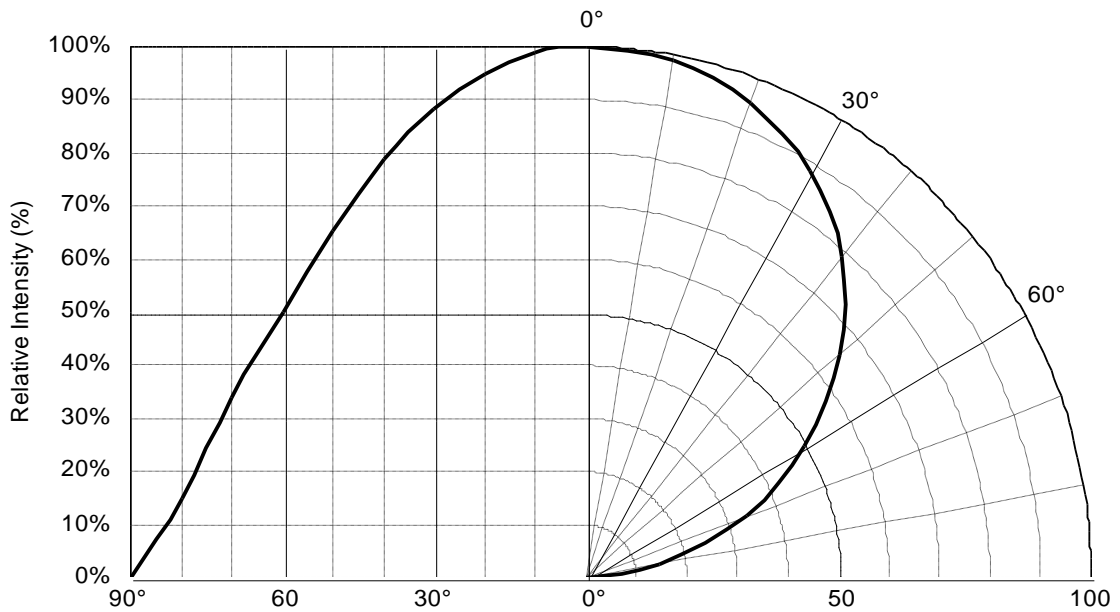


- ◆  $R_{js} = R_{th}$  of  $T_j$  to  $T_s$
- ◆  $R_{jt} = R_{th}$  of  $T_j$  to Thermal pad solder
- ◆  $R_{th}$  definition in Datasheet =  $R_{jt}$
- ◆  $R_{jt} < R_{jc}$
- ◆  $T_j = R_{js} \cdot W + T_s$

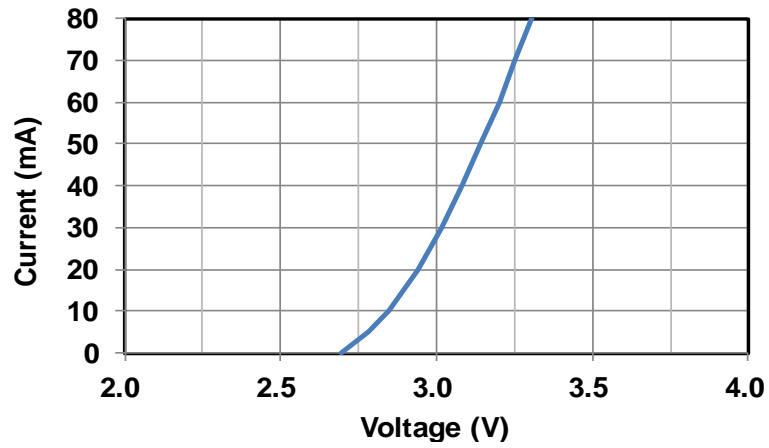
#### 4.2 Relative Spectral Power Distribution at Typical Current



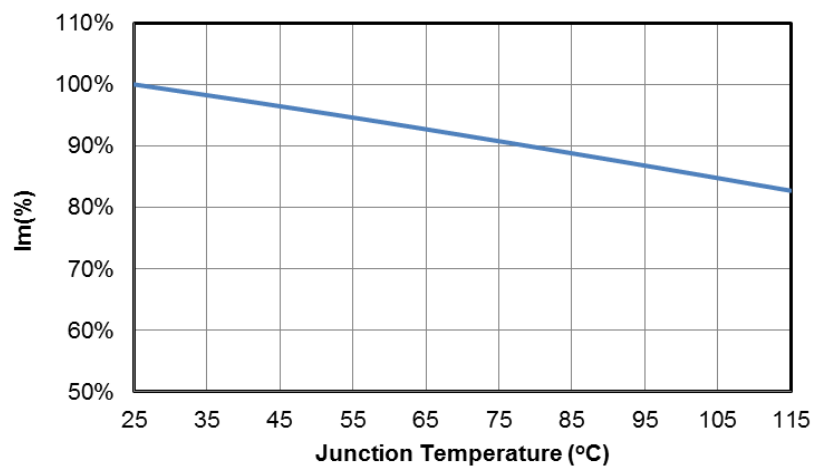
#### 4.3 Radiation Characteristics



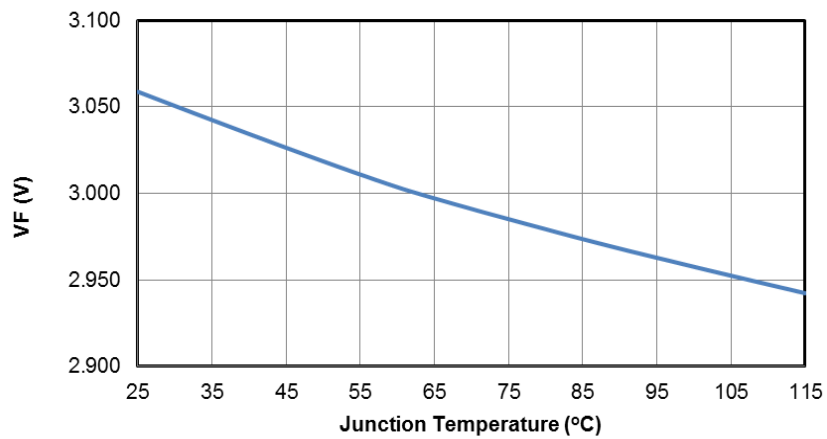
#### 4.4 Forward Current vs. Forward Voltage



#### 4.5 Relative Luminous Flux vs. Junction Temperature

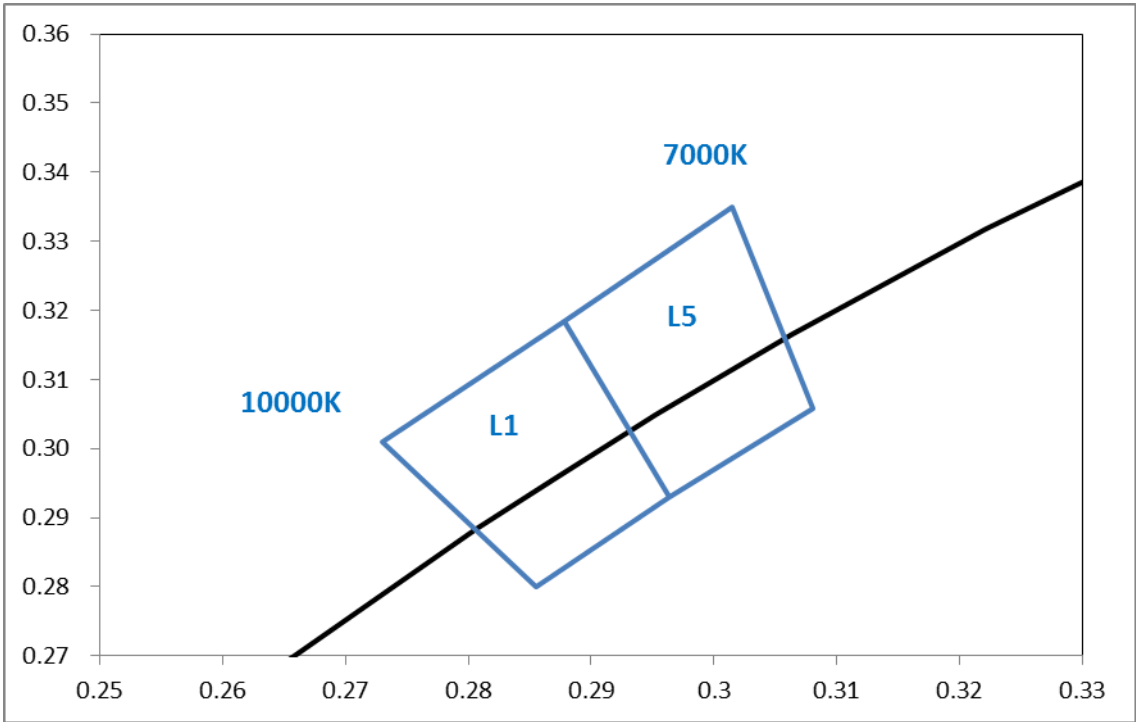


#### 4.6 Forward Voltage vs. Junction Temperature



## 5. Binning Definition

### 5.1 Color Bin



### 5.2 Color Rank

Rank	x	y
L1	0.2878	0.3185
	0.2964	0.2930
	0.2855	0.2800
	0.2730	0.3010
	0.2878	0.3185
L5	0.3015	0.3350
	0.3080	0.3058
	0.2964	0.2930
	0.2878	0.3185
	0.3015	0.3350

Tolerance on each Hue bin (x,y) is +/- 0.01.



### 5.3 Flux Bin

White	$\Phi_v$ Luminous Flux Spec. Table	
$\Phi_v$ Bin	Lumen (lm) at $I_F = 60$ mA	
	Min	Max
S0	19.4	24.0
S1	24.0	29.0

Tolerance on each Luminous Flux bin is +/- 10%.

### 5.4 Voltage Bin

$V_F$ Spec. Table		
$V_F$ Bin	Forward Voltage (volts) at $I_F = 60$ mA	
	Min	Max
V1	2.9	3.1
V2	3.1	3.2
V3	3.2	3.3
V4	3.3	3.5

Tolerance on each Forward Voltage bin is +/- 0.1V

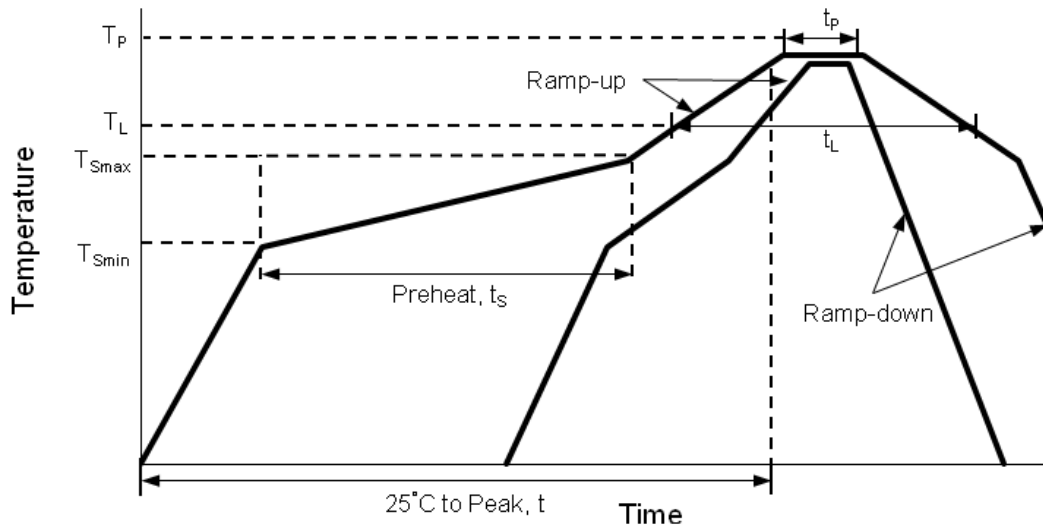
## 6. Bin Code List

※ Notes: Full Rank on Label

Example: V1 / S0 / L1

Forward Voltage Rank	Luminous Flux Rank	Color Rank
V1	S0	L1

## 7. Reflow Soldering Characteristics



Profile Feature	Lead Free Assembly
Average Ramp-Up Rate ( $T_{Smax}$ to $T_P$ )	3°C / second max
Preheat Temperature Min ( $T_{Smin}$ )	150°C
Preheat Temperature Max ( $T_{Smax}$ )	200°C
Preheat Time ( $t_{Smin}$ to $t_{Smax}$ )	60 – 180 seconds
Time Maintained Above Temperature ( $T_L$ )	217°C
Time Maintained Above Time ( $t_L$ )	60 – 150 seconds
Peak / Classification Temperature ( $T_P$ )	260°C
Time Within 5°C of Actual Peak Temperature ( $t_p$ )	5 seconds
Ramp – Down Rate	6°C / second max
Time 25°C to Peak Temperature	8 minutes max

#### Notes:

1. The LEDs can be soldered using the reflow soldering or hand soldering method. The recommended hand soldering condition is 350 °C max. and 2 secs max. for one time only, and the recommended reflow soldering condition is 260 °C max. and 5 secs max. for three times max.
2. All temperatures refer to topside of the package, measured on the package body surface.
3. The soldering condition referring to J-STD-020. The storage ambient for the LEDs should not exceed 30 °C temperature or 70% relative humidity. It is recommended that LEDs out of their original packaging are soldered within one week. For extended storage out of their original packaging, it is recommended that the LEDs were stored in a sealed container with appropriate desiccant, or desiccators with nitrogen ambient. If the LEDs were unpacked more than 168hrs, baking the LEDs at 60 °C for 60 mins before soldering process.
4. The soldering profile could be further referred to different soldering grease material characteristic. The grease vendor will provide this information.
5. A rapid-rate process is not recommended for the LEDs cooling down from the peak temperature.
6. Although the recommended reflow conditions are specified above, the reflow or hand soldering condition at the lowest possible temperature is desirable for the LEDs.
7. LiteOn cannot make a guarantee on the LEDs which have been already assembled using the dip soldering method.

## 8. Reliability Test

No	Test item	Test Condition	Duration	Number of Damaged
1	Steady State Operating Life of High Temperature (HTOL)	$T_s=85^{\circ}\text{C}$ , $I_F=60\text{mA}$	1000 hrs	0/20
2	Steady State Operating Life of Low Temperature (LTOL)	$T_a=-40^{\circ}\text{C}$ , $I_F=60\text{mA}$	1000 hrs	0/20
3	Wet Operating Life of High Temperature (WHTOL)	$T_a=60^{\circ}\text{C}/90\%\text{RH}$ , $I_F=60\text{mA}$	500 hrs	0/20
4	Pulse Wet Operating Life of High Temperature (PWHTOL)	$T_a=60^{\circ}\text{C}/90\%\text{RH}$ , $I_F=60\text{mA}$ 30mins ON/30min OFF	500 hrs	0/20
5	High Temperature Storage (HTS)	$100^{\circ}\text{C}$	1000 hrs	0/20
6	Low Temperature Storage (LTS)	$-40^{\circ}\text{C}$	1000 hrs	0/20
7	Thermal Cycle (TC)	$-40^{\circ}\text{C} \sim 100^{\circ}\text{C}$ 30min dwell 5min transfer	200 cycle	0/20
8	Thermal Shock (TS)	$-40^{\circ}\text{C} \sim 100^{\circ}\text{C}$ 20min dwell 20sec transfer	200 cycle	0/20

### Criteria for Judging the Damage

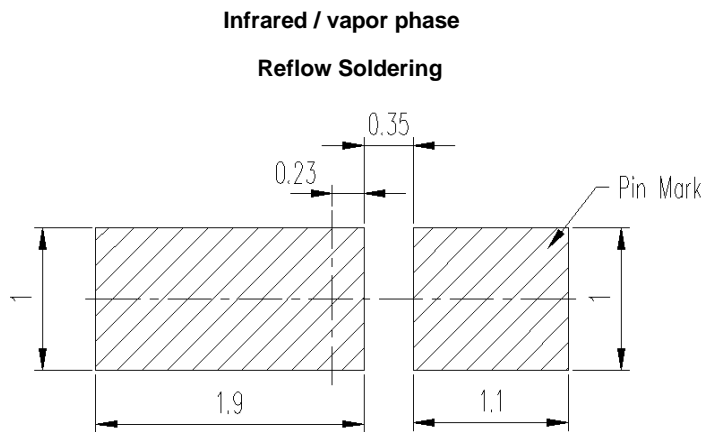
Item	Symbol	Test Condition	Criteria for Judgment	
			Min.	Max.
Forward Voltage	$V_f$	$I_F = 60\text{mA}$		U.S.L. x 1.1
Luminous Flux	$L_m$	$I_F = 60\text{mA}$	L.S.L. x 0.7	
CCX&CCY	x,y	$I_F = 60\text{mA}$		Shift<0.02

## 9. User Guide

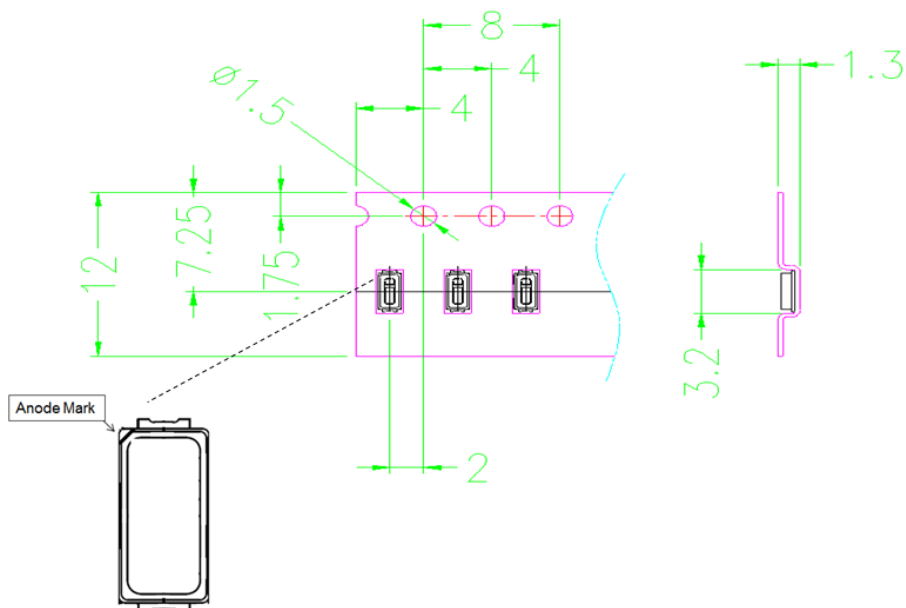
### ■ Cleaning

Do not use unspecified chemical liquid to clean LED they could harm the package. If cleaning is necessary, immerse the LED in ethyl alcohol or isopropyl alcohol at normal temperature for less than one minute.

### ■ Recommend Printed Circuit Board Attachment Pad

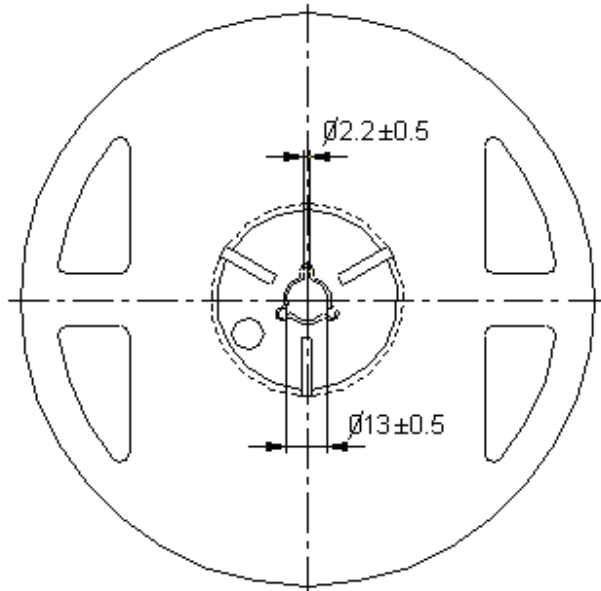


### ■ Package Dimensions of Tape

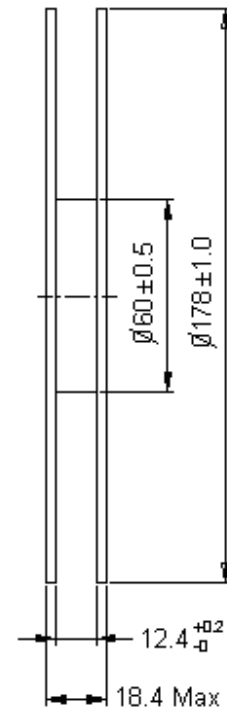


**Note:** All dimensions are in millimeters (inches).

## ■ Package Dimensions of Reel



Note: 01. The tolerance unless mentioned is  $\pm 0.1$ mm  
02. The measured unit is "mm"



### Notes:

1. Empty component pockets sealed with top cover tape.
2. 7 inch reel-3000 pieces per reel.
3. Minimum packing quantity is 500 pieces for remainders.
4. The maximum number of consecutive missing lamps is two.
5. In accordance with EIA-481-1-B specifications.

## 10. Cautions

### 10.1 Application

The LEDs described here are intended to be used for ordinary electronic equipment (such as office equipment, communication equipment and household applications). Consult Liteon's Sales in advance for information on applications in which exceptional reliability is required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as in aviation, transportation, traffic control equipment, medical and life support systems and safety devices).

### 10.2 Storage

This product is qualified as Moisture sensitive Level 3 per JEDEC J-STD-020 Precaution when handling this moisture sensitive product is important to ensure the reliability of the product.

The package is sealed:

The LEDs should be stored at 30°C or less and 90%RH or less. And the LEDs are limited to use within one year, while the LEDs is packed in moisture-proof package with the desiccants inside.

The package is opened:

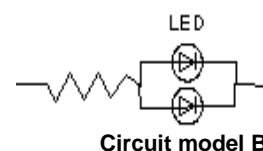
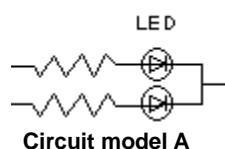
The LEDs should be stored at 30°C or less and 60%RH or less. Moreover, the LEDs are limited to solder process within 168hrs. If the Humidity Indicator shows the pink color in 10% even higher or exceed the storage limiting time since opened, that we recommended to baking LEDs at 60°C at least 24hrs. To seal the remainder LEDs return to package, it's recommended to be with workable desiccants in original package.

### 10.3 Cleaning

Use alcohol-based cleaning solvents such as isopropyl alcohol to clean the LED if necessary.

### 10.4 Drive Mode

An LED is a current-operated device. In order to ensure intensity uniformity on multiple LEDs connected in parallel in an application, it is recommended that a current limiting resistor be incorporated in the drive circuit, in series with each LED as shown in Circuit A below





(A) Recommended circuit.

(B) The brightness of each LED might appear different due to the differences in the I-V characteristics of those LEDs.

### 10.5 ESD (Electrostatic Discharge)

Static Electricity or power surge will damage the LED. Suggestions to prevent ESD damage:

- Use of a conductive wrist band or anti-electrostatic glove when handling these LEDs.
- All devices, equipment, and machinery must be properly grounded.
- Work tables, storage racks, etc. should be properly grounded.
- Use ion blower to neutralize the static charge which might have built up on surface of the LED's plastic lens as a result of friction between LEDs during storage and handling.

ESD-damaged LEDs will exhibit abnormal characteristics such as high reverse leakage current, low forward voltage, or “no lightup” at low currents. To verify for ESD damage, check for “light up” and Vf of the suspect LEDs at low currents. The Vf of “good” LEDs should be  $>2.0V@0.1mA$  for InGaN product and  $>1.4V@0.1mA$  for AlInGaP product.

### 10.6 Suggested Checking List:

- Training and Certification
  1. Everyone working in a static-safe area is ESD-certified?
  2. Training records kept and re-certification dates monitored?
- Static-Safe Workstation & Work Areas
  1. Static-safe workstation or work-areas have ESD signs?
  2. All surfaces and objects at all static-safe workstation and within 1 ft measure less than 100V?
  3. All ionizer activated, positioned towards the units?
  4. Each work surface mats grounding is good?
- Personnel Grounding
  1. Every person (including visitors) handling ESD sensitive (ESDS) items wear wrist strap, heel strap or conductive shoes with conductive flooring?
  2. If conductive footwear used, conductive flooring also present where operator stand or walk?

3. Garments, hairs or anything closer than 1 ft to ESD items measure less than 100V\*?
4. Every wrist strap or heel strap/conductive shoes checked daily and result recorded for all DLs?
5. All wrist strap or heel strap checkers calibration up to date?

Note: \*50V for Blue LED.

- Device Handling
  1. Every ESDS items identified by EIA-471 labels on item or packaging?
  2. All ESDS items completely inside properly closed static-shielding containers when not at static-safe workstation?
  3. No static charge generators (e.g. plastics) inside shielding containers with ESDS items?
  4. All flexible conductive and dissipative package materials inspected before reuse or recycle?
- Others
  1. Audit result reported to entity ESD control coordinator?
  2. Corrective action from previous audits completed?
  3. Are audit records complete and on file?

#### 10.7 Others:

- Do not put any pressure on the light emitting surface either by finger or any hand tool and do not stack the products. Stress or pressure may cause damage to the wires of the LED array.
- This product is not designed for the use under any of the following conditions, please confirm the performance and reliability are well enough if you use it under any of the following conditions
- Do not use sulfur-containing materials in commercial products including the materials such as seals and adhesives that may contain sulfur.
- Do not put this product in a place with a lot of moisture (over 85% relative humidity), dew condensation, briny air, and corrosive gas (Cl, H<sub>2</sub>S, NH<sub>3</sub>, SO<sub>2</sub>, NO<sub>x</sub>, etc.), exposure to a corrosive environment may affect silver plating.
- The appearance and specifications of the product may be modified for improvement without prior notice.